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MOSFET - Power, Single N-Channel, D²PAK7

100 V, 4.1 mΩ, 203 A

NTBGS004N10G

Features

- Low R_{DS(on)}
- High Current Capability
- Wide SOA
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

• Hot Swap in 48 V Systems

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

| | | | - | | |
|---|--|-----------------------|-----------------------------------|-----------------|------|
| Parameter | | | Symbol | Value | Unit |
| Drain-to-Source Voltag | rain-to-Source Voltage | | V _{DSS} | 100 | V |
| Gate-to-Source Voltage | e-to-Source Voltage | | V _{GS} | ±20 | V |
| $\begin{array}{l} \text{Continuous Drain} \\ \text{Current } \textbf{R}_{\theta JC} \\ \text{(Note 2)} \end{array}$ | Steady State | T _C = 25°C | Ι _D | 203 | A |
| Power Dissipation $R_{\theta JC}$ (Note 2) | olulo | | P _D | 340 | W |
| Continuous Drain Current R _{θJA} (Notes 1, 2) | Steady State | T _A = 25°C | ۱ _D | 21 | A |
| Power Dissipation $R_{\theta JA}$ (Notes 1, 2) | Siale | State | PD | 3.7 | W |
| Pulsed Drain Current | $T_A = 25^{\circ}C$, $t_p = 10 \ \mu s$ | | I _{DM} | 2983 | А |
| Operating Junction and | Storage T | emperature | T _J , T _{stg} | –55 to + 175 | °C |
| Source Current (Body Diode) | | | IS | 283 | А |
| Single Pulse Drain-to-Source Avalanche Energy ($I_L = 106 A_{pk}$, L = 0.1 mH) | | | E _{AS} | 561 | mJ |
| Lead Temperature for S (1/8" from case for 10 s) | | urposes | ΤL | 260 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Surface-mounted on FR4 board using a 1 in², 1 oz. Cu pad.

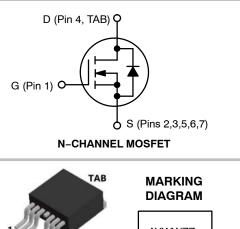
The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

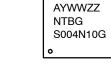


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| V _{(BR)DSS} | R _{DS(ON)} MAX | I _D MAX |
|----------------------|-------------------------|--------------------|
| 100 V | 4.1 mΩ @ 10 V | 203 A |





A = Assembly Location

Y = Year

D²PAK7 CASE 418AY

WW = Work Week

ZZ = Assembly Lot Code

NTBGS004N10G = Specific Device Code

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|--------------|----------------------------------|-----------------------|
| NTBGS004N10G | D ² PAK7 (Pb-Free) | 800 / Tape & Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

THERMAL RESISTANCE MAXIMUM RATINGS

| Parameter | Symbol | Value | Unit |
|---|---------------------|-------|------|
| Junction-to-Case - Steady State (Note 2) | $R_{	ext{	heta}JC}$ | 0.44 | °C/W |
| Junction-to-Ambient - Steady State (Note 2) | $R_{	ext{	heta}JA}$ | 40 | |

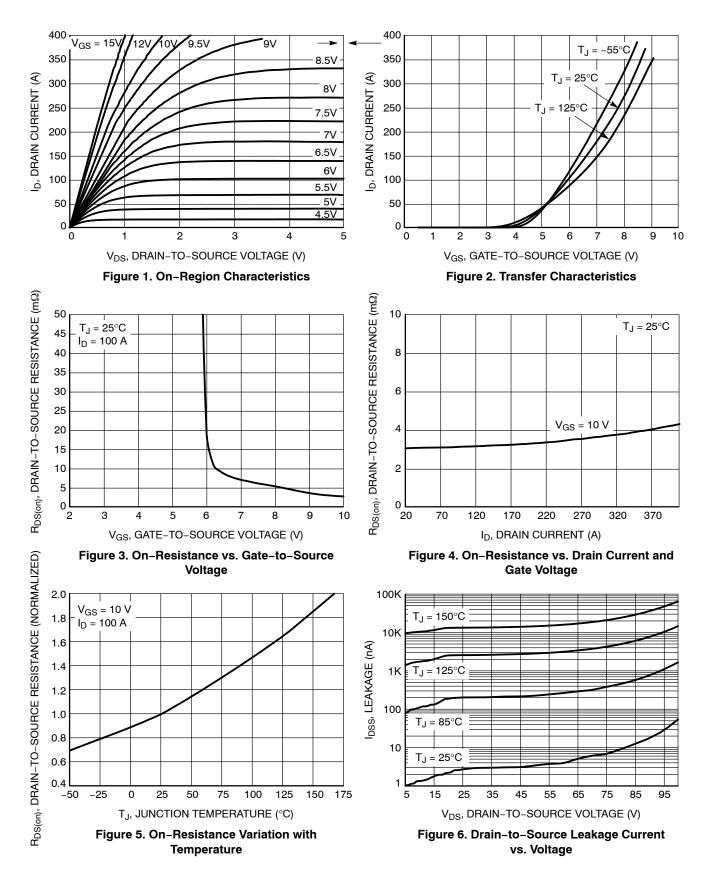
ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

| Parameter | Symbol | Test Condition | | Min | Тур | Max | Unit |
|--|--|---|------------------------|-----|-------|-----|-------|
| OFF CHARACTERISTICS | | | | | | | |
| Drain-to-Source Breakdown Voltage | V _{(BR)DSS} | V_{GS} = 0 V, I_D = 250 μ A | | 100 | | | V |
| Drain-to-Source Breakdown Voltage Temperature Coefficient | V _{(BR)DSS} / T _J | I_D = 250 µA, ref to 25°C | | | 81.3 | | mV/°C |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{GS} = 0 V,$ | $T_J = 25^{\circ}C$ | | | 1.0 | μA |
| | | V _{DS} = 80 V | T _J = 125°C | | | 100 | μA |
| Gate-to-Source Leakage Current | I _{GSS} | V _{DS} = 0 V, V _{GS} = 20 V | | | | 100 | nA |
| ON CHARACTERISTICS (Note 3) | | | | | | | |
| Gate Threshold Voltage | V _{GS(TH)} | V _{GS} = V _{DS} , I _D = | = 500 μA | 2.0 | | 4.0 | V |
| Negative Threshold Temperature Coefficient | V _{GS(TH)} /T _J | I _D = 500 μA, ref | to 25°C | | -9.3 | | mV/°C |
| Drain-to-Source On Resistance | R _{DS(on)} | V _{GS} = 10 V, I _D | = 100 A | | 3.0 | 4.1 | mΩ |
| Forward Transconductance | 9 FS | V _{DS} = 5 V, I _D = | = 100 A | | 71 | | S |
| Gate-Resistance | R _G | T _A = 25° | С | | 0.42 | | Ω |
| CHARGES, CAPACITANCES & GATE RESIS | CHARGES, CAPACITANCES & GATE RESISTANCE | | | | | | |
| Input Capacitance | C _{ISS} | | | | 12100 | | |
| Output Capacitance | C _{OSS} | V _{GS} = 0 V, V _{DS} = 50 | V, f = 1 MHz | | 1170 | | рF |
| Reverse Transfer Capacitance | C _{RSS} | | | | 165 | | |
| Total Gate Charge | Q _{G(TOT)} | V _{GS} = 10 V, V _{DS} = 50 V; I _D = 100 A | | | 178 | | |
| Threshold Gate Charge | Q _{G(TH)} | | | | 79 | | nC |
| Gate-to-Source Charge | Q _{GS} | | | | 66 | | |
| Gate-to-Drain Charge | Q _{GD} | | | | 43 | | |
| Plateau Voltage | V _{GP} | | | | 6.0 | | V |
| SWITCHING CHARACTERISTICS (Note 4) | | | | | | | |
| Turn-On Delay Time | t _{d(ON)} | | | | 44 | | |
| Rise Time | t _r | V _{GS} = 10 V, V _{DS} | s = 50 V. | | 41 | | 1 |
| Turn-Off Delay Time | t _{d(OFF)} | $I_{\rm D} = 100 \text{ A}, \text{ R}_{\rm G} = 4.7 \Omega$ | | | 81 | | ns |
| Fall Time | t _f | | | | 29 | | |
| DRAIN-SOURCE DIODE CHARACTERISTICS | | | | | | | |
| Forward Diode Voltage | V _{SD} | V _{GS} = 0 V, | $T_J = 25^{\circ}C$ | | 0.88 | 1.2 | |
| | | $I_{\rm S} = 100 \text{A}$ $T_{\rm J} = 125^{\circ}\text{C}$ | | | 0.77 | | V |
| Reverse Recovery Time | t _{RR} | V _{GS} = 0 V, dI _S /dt = 100 A/µs, I _S = 50 A | | | 74 | | |
| Charge Time | ta | | | | 46 | | ns |
| Discharge Time | t _b | | | | 29 | | |
| Reverse Recovery Charge | Q _{RR} | | | | 151 | | nC |

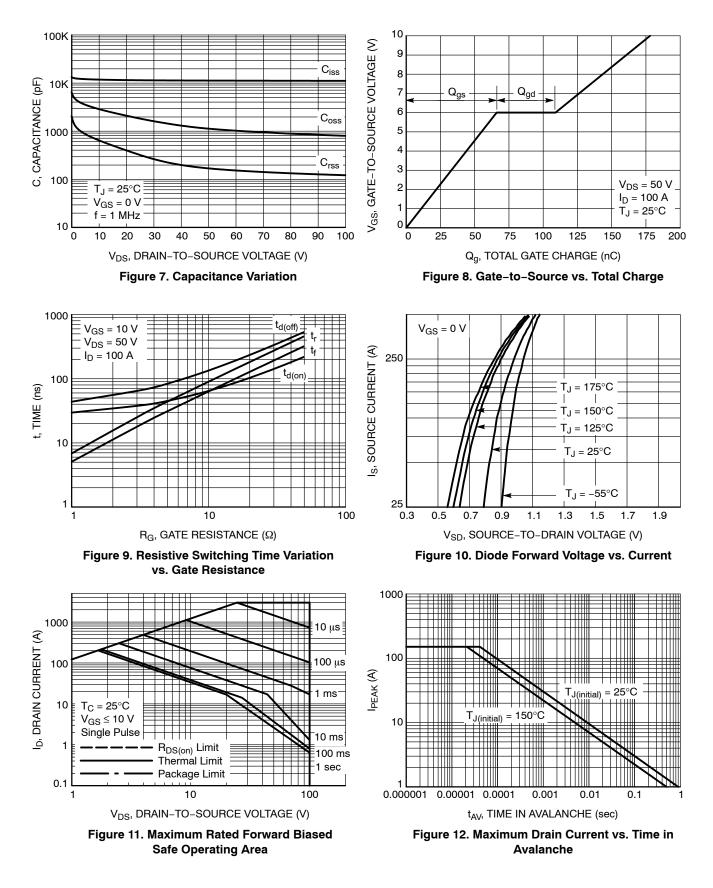
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$.

4. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

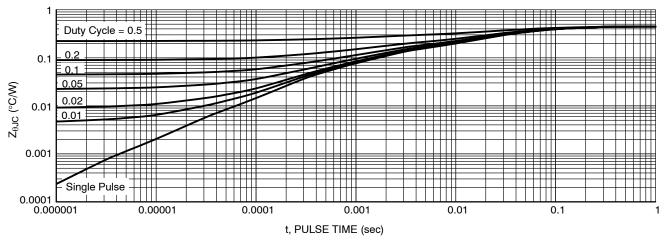
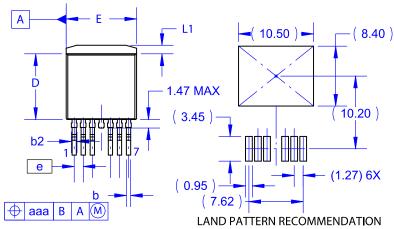


Figure 13. Transient Thermal Impedance

PACKAGE DIMENSIONS

D²PAK7 (TO-263 7 LD) CASE 418AY **ISSUE C**

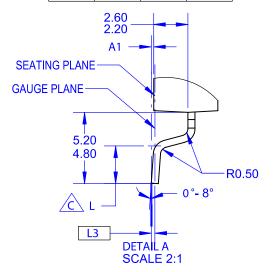


NOTES:

A. PACKAGE CONFORMS TO JEDEC TO-263 VARIATION CB EXCEPT WHERE NOTED. B. ALL DIMENSIONS ARE IN MILLIMETERS.

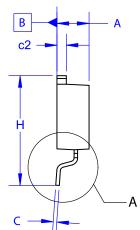
OUT OF JEDEC STANDARD VALUE. D. DIMENSION AND TOLERANCE AS PER ASME Y14.5-1994. E. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS. F. LAND PATTERN RECOMMENDATION PER IPC. TO127P1524X465-8N.

| MILLIMETERS | | | | | |
|-------------|-------|-------|-------|--|--|
| DIM | MIN | NOM | MAX | | |
| Α | 4.30 | 4.50 | 4.70 | | |
| A1 | 0.00 | 0.10 | 0.20 | | |
| b2 | 0.70 | 0.80 | 0.90 | | |
| b | 0.50 | 0.60 | 0.70 | | |
| С | 0.40 | 0.50 | 0.60 | | |
| c2 | 1.20 | 1.30 | 1.40 | | |
| D | 9.00 | 9.20 | 9.40 | | |
| D1 | 7.70 | ~ | ~ | | |
| Е | 9.70 | 9.90 | 10.20 | | |
| E1 | 8.38 | 8.58 | 8.78 | | |
| е | ~ | 1.27 | ~ | | |
| Н | 15.10 | 15.40 | 15.70 | | |
| L | 2.44 | 2.64 | 2.84 | | |
| L1 | 1.00 | 1.20 | 1.40 | | |
| L3 | ~ | 0.25 | ~ | | |
| aaa | ~ | ~ | 0.25 | | |



E1 Г D1 4

l 7



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